

20th IEEE European Test Symposium

Cluj-Napoca, Romania May 25 – 29, 2015

http://www.ieee-ets.org

Vendor Sessions – Call for Submissions

The IEEE European Test Symposium (ETS) is Europe's premier forum dedicated to presenting and discussing scientific results, emerging ideas, practical applications, hot topics, and new trends in the area of electronic-based circuit and system testing.

ETS 2015 (ETS'15) will take place at Grand Hotel Italia in Cluj-Napoca. It is organized by the Technical University of Cluj-Napoca, which co-sponsors the event jointly with the IEEE Council on Electronic Design Automation (CEDA).

ETS'15 is offering commercial vendors the opportunity to give technical presentations in a track parallel to the technical paper sessions. These presentations will be listed in the symposium program along with the technical sessions, and should be targeted to the ETS technical audience. The Vendor Sessions differ from other ETS presentations in that company names, logos, and product names may be mentioned explicitly. Typical content includes product descriptions, case studies, best practices, and user testimonials.

Presentation opportunities of 30-minute duration are available on a first-come first-served basis, but priority will be given to those companies that are also corporate supporters of ETS'15 – see below. Attendance at the sessions is open to all symposium attendees, and vendor representatives will be able to hand out literature at the session. Proposals for the Vendor Sessions should be technical or application focused, rather than overtly sales-and-marketing focused. Proposal selection is based on the technical content and relevance to ETS audience and topics. <u>Priority will be given to ETS supporters</u>. The areas of interest of ETS'15 include (but are not limited to) the following topics:

- Analog Test
- ATE Hardware and Software
- Automatic Test Generation
- Board Test and Diagnosis
- Boundary Scan Test
- Built-In Self Test (BIST)
- Current-Based Test
- Defect-Based Test
- Delay and Performance Test
- Dependability and Functional Safety
- ullet Design for Test(ability) (DfT)
- Design for Manufacturing (DfM)
- Diagnosis and Silicon Debug
- Economics of Test
- Emerging Technologies
- Failure Analysis

- Fault Modelling and Simulation
- Fault Tolerance
- GPU Test
- High-Speed I/O Test
- Low-Power IC Test
- Memory Test and Repair
- MEMS Test
- Microprocessor Test
- Mixed-Signal Test
- Multi-/Many-core Processor Test
- Nanotechnology Test
- On-Line Test
- Power Issues in Test
- Reconfigurable System Test
- $\bullet \ Reliability$
- RF Test

- · Security and Trust Issues in Test
- Self-Repair
- Sensor Test
- Signal Integrity Test
- SiP. Stacked, 3D IC Test
- SoC Test
- Soft Errors
- Standards in Test
- System Test
- Test Compression
- Test Quality
- Test Synthesis
- Thermal Issues in Test
- Validation and Verification
- Variability Issues in Test
- Yield Analysis and Enhancement

Submissions

A submission to the ETS'15 Vendor Sessions can be an abstract, extended abstract or full paper (max. six pages); submission of a full paper is preferred, but not required. Proposals should be submitted via the ETS'15 website; detailed submissions instructions can also be found there (go to http://www.ets15.ro, and then select Vendor sessions/Submission Site). Key dates for submissions:

Submission deadline (for Vendor Sessions only):
Notification of acceptance:
February 10, 2015
February 20, 2015

• Camera-ready manuscript: April 1, 2015

ETS'15 Corporate Support

Every year, ETS is financially supported by several companies. The support money is used to reduce the registration fees and hence make the event more accessible to all its attendees. In return, the corporate supporters are allowed to make publicity in various ways. ETS has defined four different support grades (Bronze, Silver, Gold, and Platinum), each with different support amounts and publicity options. To find out more, contact Said Hamdioui, details below.

More Information

Said Hamdioui – ETS'15 Industrial Relations Chair

Phone: +31 - 15 278 3643 +31 - 62 880 2494

E-mail: S.Hamdioui@tudelft.nl

Visit the ETS'15 web page at: http://www.ets15.ro.







